



# PAA191 Dual Single-Pole, Normally Open OptoMOS<sup>®</sup> Relays

Parameter	Rating	Units
Load Voltage	400	V <sub>P</sub>
Load Current	250	mA
Max R <sub>ON</sub>	8	Ω

### **Features**

- 5000V<sub>rms</sub> Input/Output Isolation
- Small 8-Pin Packages
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount Tape & Reel Version Available

# **Applications**

- Telecommunications
- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Hook Switch
- Dial Pulsing
- Ground Start
- Ringing Injection
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
  - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

#### Description

PAA191 is a dual 400V, 250mA,  $8\Omega$  normally open (1-Form-A) solid state relay. The relay outputs are constructed with efficient MOSFET switches and photovoltaic die that use Clare's patented OptoMOS architecture while the inputs, highly efficient GaAlAs infrared LEDs, provide the optically coupled control.

This performance leader provides a high blocking voltage capability, and features an enhanced  $5000V_{\rm rms}$  isolation barrier beween the input and output circuits of the relay.

### **Approvals**

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

# **Ordering Information**

Part #	Description	
PAA191	8-Lead DIP (50/tube)	
PAA191S	8-Lead Surface Mount (50/tube)	
PAA191STR	8-Lead Surface Mount (1000/Reel)	

# **Pin Configuration**



#### Switching Characteristics of Normally Open Devices







## Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	400	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation <sup>1</sup>	150	mW
Total Power Dissipation <sup>2</sup>	800	mW
Isolation Voltage, Input to Output	5000	V <sub>rms</sub>
Operational Temperature	-40 to +85	٥C
Storage Temperature	-40 to +125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Derate linearly 1.33 mW / °C
Derate linearly 6.67 mW / °C

## **Electrical Characteristics @ 25°C**

Parameter	Conditions	Symbol	Min	Тур	Max	Units
Output Characteristics						
Load Current *						
Continuous, AC/DC Configuration	-	IL I	-	-	250	
Peak	10ms	I <sub>LPK</sub>	-	-	500	- mA
On-Resistance, AC/DC Configuration	I <sub>L</sub> =250mA	R <sub>on</sub>	-	6	8	Ω
Off-State Leakage Current	V <sub>L</sub> =400V <sub>P</sub>	ILEAK	-	-	1	μΑ
Switching Speeds						
Turn-On	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>on</sub>	-	-	3	
Turn-Off		t <sub>off</sub>	-	-	1	ms
Output Capacitance	V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	25	-	pF
Input Characteristics						
Input Control Current	I <sub>L</sub> =250mA	I <sub>F</sub>	-	-	5	mA
Input Dropout Current	-	I <sub>F</sub>	0.2	0.7	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA
Common Characteristics						
Capacitance, Input to Output	-	C <sub>I/O</sub>	-	3	-	pF

\*NOTE: If both poles operate simultaneously, then load current must be derated so as not to exceed the package power dissipation value.





## **PERFORMANCE DATA\***





Typical I<sub>F</sub> for Switch Operation (N=50, I<sub>L</sub>=250mA<sub>DC</sub>, T<sub>A</sub>=25°C) 25 20 Device Count (N) 15 10 5 0 1.5 2.1 2.7 3.3 3.9 4.5 5.1 LED Current (mA)



Typical Blocking Voltage Distribution (N=50,  $T_{a}$ =25°C)



Typical LED Forward Voltage Drop (N=50, I<sub>F</sub>=5mA, T<sub>A</sub>=25°C)

Turn-On (ms)







Typical Turn-Off vs. LED Forward Current (I<sub>L</sub>=250mA<sub>pc</sub>)





\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.



#### **PERFORMANCE DATA\***



Time

\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Temperature (°C)



### **Manufacturing Information**

#### **Moisture Sensitivity**

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
PAA191 / PAA191S	MSL 1

#### **ESD Sensitivity**



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

#### **Reflow Profile**

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
PAA191 / PAA191S	250°C for 30 seconds

#### **Board Wash**

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.



5



# **MECHANICAL DIMENSIONS**







### PAA191S Tape & Reel



#### For additional information please visit our website at: www.clare.com

Clare, Inc. makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in Clare's Standard Terms and Conditions of Sale, Clare, Inc. assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of Clare's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. Clare, Inc. reserves the right to discontinue or make changes to its products at any time without notice.